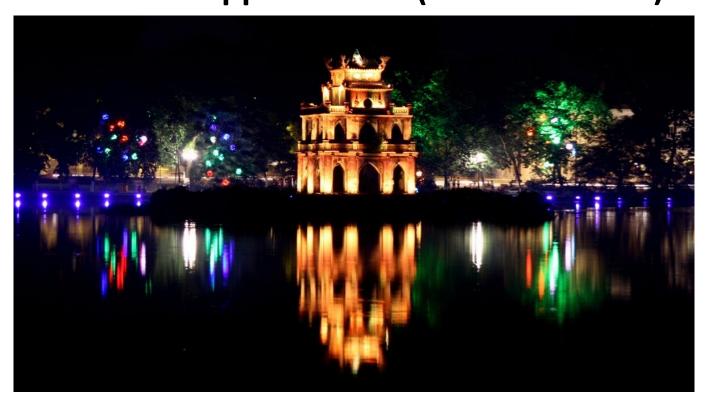








# 2019 International Conference on "Physics and Mechanics of New Materials and Their Applications" (PHENMA 2019)



Hanoi, Vietnam, November 7-10, 2019

http://phenma2019.math.sfedu.ru

# **First Announcement**

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# **Scope of the Conference**

The scope of the conference includes the following topics, namely:

- (i) Materials: Ferro-Piezoelectrics, Semiconductors, Superconductors, Environmental Materials, Medical Materials, Composite, Ceramics, Thin Films, Nanomaterials, New Materials for Additive Manufacturing, Metal Engineering Materials, etc.
- (ii) **Synthesis & Processing:** Powder Processing, Processing Technologies, Piezoelectric Technologies, MEMS-Processing, etc.
- (iii) Characterization and Research Methods: Microstructure Properties, Physical Properties, Mechanical Properties, Strength Properties, Finite-Element Modeling, Mathematical Modeling, Physical Modeling, Physical Experiment, etc.
- (iv) **Applications:** MEMS, Hetero-structures, Piezotransducers, Superconductive Devices, Light-Emitting Diodes, Multimedia Communication, Fiber Reinforced Composites, Construction Health Monitoring, Lubricant and Tribology, Waste etc.
- (v) Energy Harvesting: Materials, Methods and Applications
- (vi) Underwater Technologies: Underwater Communication, Marine Engineering, Power System, Ocean Energy, etc.
- (vii) Industry and Management: CAD/CAM/CAE Application, Industrial Instruments, EDM, Materials Machining, Machines, etc.

The conference will consist of keynote, oral and poster sessions.

## **Objectives of the Conference**

This conference continues thematic of the First Taiwanese-Russian Symposium "Physics and Mechanics of New Materials and Their Applications" (June 4-6, 2012, Rostov-on-Don, Russia), selected reports of which have been published as edited book "Physics and Mechanics of New Materials and Their Applications" by Nova Science Publishers, New York; 2013 International Symposium on "Physics and Mechanics of New Materials and Underwater Applications" (June 5-8, 2013, Kaohsiung, Taiwan), selected reports of which have been published as Springer Proceedings "Advanced Materials -Physics, Mechanics and Applications" by Springer, Heidelberg, New York, Dordrecht, London; 2014 International Symposium on "Physics and Mechanics of New Materials and Underwater Applications" (March 27-29, 2014, Khon Kaen, Thailand), selected reports of which have been published as edited book "Advanced Materials - Studies and Applications" by Nova Science Publishers, New York; 2015 International Conference on "Physics and Mechanics of New Materials and Their Applications" (May 19-22, 2015, Azov, Russia), selected reports of which have been published as Springer Proceedings "Advanced Materials - Manufacture, Physics, Mechanics and Applications" by Springer, Heidelberg, New York, Dordrecht, London and as Proceedings of the 2015 International Conference on "Physics, Mechanics of New Materials and Their Applications", devoted to 100-th Anniversary of the Southern Federal University by Nova Science Publishers, New York; 2016 International Conference on "Physics and Mechanics of New Materials and Their Applications" (July 19-22, 2016, Surabaya, Indonesia), selected reports of which have been published as Springer Proceedings "Advanced Materials – Techniques, Physics,

Mechanics and Applications" by Springer, Heidelberg, New York, Dordrecht, London and as Proceedings of the 2016 International Conference on "Physics, Mechanics of New Materials and Their Applications" by Nova Science Publishers, New York; 2017 International Conference on "Physics and Mechanics of New Materials and Their Applications" (October 14-16, 2017, Jabalpur, India), selected reports of which have been published as Springer Proceedings "Advanced Materials - Proceedings of the International Conference on "Physics and Mechanics of New Materials and Their Applications", PHENMA 2017" by Springer, Heidelberg, New York, Dordrecht, London, as Proceedings of the 2017 International Conference on "Physics, Mechanics of New Materials and Their Applications" by Nova Science Publishers, New York and in two special issues of International journal "Material Physics and Mechanics", Saint-Petersburg, Russia; 2018 International Conference on "Physics and Mechanics of New Materials and Their Applications" (August 9-11, 2018, Busan, South Korea), selected reports of which will be published as Springer Proceedings "Advanced Materials - Proceedings of the International Conference on "Physics and Mechanics of New Materials and Their Applications", PHENMA 2018" by Springer, Heidelberg, New York, Dordrecht, London, as Proceedings of the 2018 International Conference on "Physics, Mechanics of New Materials and Their Applications" by Nova Science Publishers, New York and in the International journals: "Material Physics and Mechanics" (Saint-Petersburg, Russia), "Applied Sciences" (MDPI), and "Modern Physics Letters B" (World Scientific Publishing).

General conference topics include, but are not restricted to advanced materials, their synthesis and processing, characterization, research methods, and applications.

In particular, the reports will be devoted to novel piezoelectrics, nanomaterials, other advanced materials and composites with special properties, manufactured on the base of developed processing techniques and modern approaches of chemistry, physics, mechanics and materials science, and also broad applications of the materials including industry and management. The publications will present corresponding mathematical models, physical experiments, computer simulation, nano- and piezoelectric applications, etc.

Another goal of the conference is to attract researchers from countries of Asia and Asian-Pacific Ocean Region, other countries to fulfillment of joint investigations and scientific collaboration.

#### **Abstracts**

The abstracts up to one page in WORD (\*.docx) should be submitted by e-mail before May 01, 2019 to: <a href="mailto:parinov\_ia@mail.ru">parinov\_ia@mail.ru</a> and duplicated to <a href="mailto:ppr@math.rsu.ru">ppr@math.rsu.ru</a>. Authors will be notified by July 01, 2019 whether the contribution has been accepted.

The format to be used is a text within one standard A4 page. A 12point font should be used. The title appears centered. It is separated by an empty line from the author's name, also centered. The name of the author who presents the contribution should be underlined. An empty line separates the name from the affiliation, also centered. The Abstracts book will be published before conference.

# **Proceedings**

The proceedings will be published as two edited books: "Advanced Materials" by Springer, Heidelberg, New York, Dordrecht, London and Proceedings of the 2019 International Conference on "Physics, Mechanics of New Materials and Their Applications" by Nova Science Publishers, New York and also in special issue of the International journal "Material Physics and Mechanics", Saint-Petersburg, Russia. The deadline for contributions to the proceedings submitted electronically by the authors is December 01, 2019. It is assumed the length of the Springer manuscripts will be up to 15 pages, Nova manuscripts and Russian journal papers — up to 6 pages. Instructions for preparing the manuscripts will be sent to all presenting authors after the abstracts have been accepted. A paper charge will be covered by organizing fee.

The official language of the conference will be **English**.

#### **Secretariat of the Conference**

**Address**: 226 C1 Building, Hanoi University of Science and Technology

**Fax** : +84) (024) 38 680 585 **Phone** : +84) (024)38692007

e-mail: parinov\_ia@mail.ru; ppr@math.rsu.ru, an.phamduc@hust.edu.vn;

quang.nguyenhuu@hust.edu.vn

Web-Site: http://phenma2019.math.sfedu.ru/

### **Registration and Fees**

Registration will be available by e-mail. Corresponding Registration Form will be presented in information distributions of PHENMA-2019 Secretariat and should be submitted by e-mail to <a href="mailto:parinov\_ia@mail.ru">parinov\_ia@mail.ru</a> and duplicated to <a href="mailto:ppr@math.rsu.ru">ppr@math.rsu.ru</a>

All **full participants** must register and pay the Registration Fee up to **October 1**, **2019**, which will be **US\$400** and include social and technical programs, coffee-break, book of the Conference Abstracts and electronic version of the Conference Proceedings. The electronic versions of the Conference Proceedings published after conference will be sent by e-mail to the corresponding authors (1 book per paper) by the Conference Secretariat.

For **young scientists** (**up to 35 years old**) special registration fee is stated which will be **US\$100**. This registration fee does not include the Conference Proceedings.

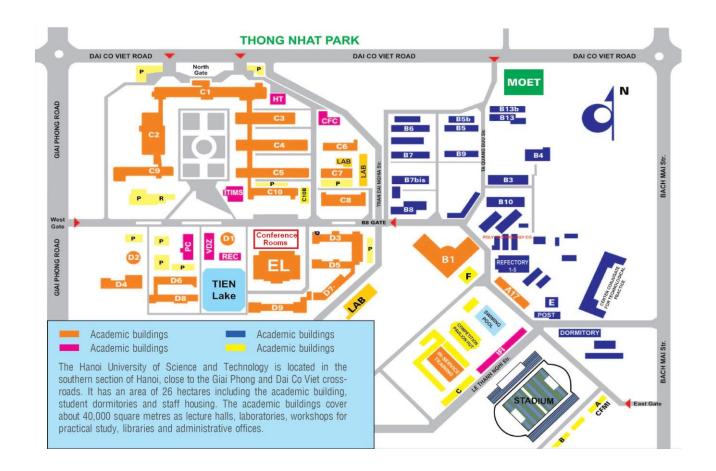
Special payment will be made for Symposium Banquet.

# **Registration Desk**

The Abstract book with Conference Schedule, tickets for social events and other conference materials will be available at the Conference Registration Desk.

Additional information will be available at the Conference site.

#### MAP AND GUIDANCE TO THE HANOI UNIVERSITY OF SCIENCE AND TECHNOLOGY



#### Hanoi

Hanoi, located on the banks of the Red River, is one of the most ancient capitals in the world, where you can find well-preserved traditional buildings, ancient pagodas, and unique museums within the city Centre. A great place to explore on foot, this city is also known for its delectable cuisine, vibrant nightlife, silks and handicrafts, as well as a multicultural community that's made up of French, Russian, Korea, China and others countries influences. Meanwhile, its tranquil countryside is a short drive away, featuring lush parks, verdant mountains, and traditional villages, and not forgetting, the iconic Ha Long Bay.

To visit somewhere in Hanoi during your stay, please visit:

http://www.vietnam-guide.com/hanoi/top10/top10-hanoi-attractions.htm

# **Method of Payment**

Payment to be made in USD in direct transfer to:

**Account Name (Beneficiary):** Vietnam Association for Science Editing **Bank Name:** Military Commercial Joint Stock Bank / Hoan Kiem Branch

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**SWIFT (Bank Code): MSCBVNVX** 

ACCOUNT: 0671101530002

**Phone:** Mr. N. Huu-Quang +84 (0)942167123.

Recipient bank detail (VND) (For Vietnamese only)

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Tên ngân hàng: Ngân hàng TMCP Quân Đội Chi nhánh Hoàn Kiếm

Địa chỉ: 1 Đại Cổ Việt, Hai Bà Trưng, Hà Nội, 10000, Việt Nam

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Phone: +84 24 3852 2522

Website: <a href="http://www.kimlientourism.com.vn">http://www.kimlientourism.com.vn</a>

**2. Parkside Sunline Hotel** (~ 500 metters from Hanoi University of Science and Technology)

Address: 72-74 Dai Co Viet Street, Hà Nội

Phone: +84 24 3974 7272

Website: <a href="http://parksidesunline.vn/intro-vi.htm">http://parksidesunline.vn/intro-vi.htm</a>

**3. Riverside Boutique Hotel** (~ 1.3 km from Hanoi University of Science and Technology)

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Phone: +84 24 3984 0966

Website: <a href="http://riversideboutiquehotel.com">http://riversideboutiquehotel.com</a>

**4. Sahul Hotel** (~ 0.6 km from Hanoi University of Science and Technology)

Address: 684 Minh Khai, Vĩnh Tuy, Hà Nội

Phone: +84 24 3987 4720

Website: http://sahulhotel.com

**5. Asia Hotel Hanoi** (~ 1.6 km from Hanoi University of Science and Technology)

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Phone: +84 24 3821 2045

Website: <a href="http://www.asiahotelvn.com">http://www.asiahotelvn.com</a>

# **Dates & Deadlines**

Deadline for Abstracts:

Notification of Acceptance:

Registration with Payment:

Registration and arrival in Hanoi:

Conference:

Departure:

Deadline for Full Papers:

May 01, 2019

October 01, 2019

November 07, 2019

November 08-10, 2019

December 01, 2019

December 01, 2019